

Fläktlös PC Gen 12/13, 2x2,5 Gbit, 6xUSB, RS232/422/485,

FEATURES

- Intel® 13:e/12:e generationens Core™ 35W/65W LGA1700 CPU
- SODIMM MAX. 32GB DDR4 3200
- 2x 2,5 GbE
- 4x USB3.2 Gen 1 med skruvlås
- 1x M.2 2280
- Gen4 x4 NVMe
- 1x 3,5"/2,5" SATA HDD/SSD-lagring
- 4-CH isolerad DI och 4-CH isolerad DO
- TPM 2.0
- VGA + DP dubbla displayutgångar
- 25°C till 60°C fläktlös drift (behöver specialminne och SSD)
- Kompakt 212 x 165 x 80 mm
- Kan vägg- och DIN-monteras behöver specialbeställas
- 1x3-PIN-uttag 8~35Vdc fjärrkontroll PÅ/AV



SPECIFICATIONS

CPU	:	LGA 1700 socket, 65W/35W 13th Gen Core, 12th Gen 35w/65W TDP, call for CPU list,
Chipset	:	Intel® H610E platform controller hub
Digital I/O	:	4-CH isolated DI and 4-CH isolated DO
USB	:	4x USB 3.2 Gen1 (5 Gbps) ports 2x USB 2.0 ports
Serial	:	1x software-programmable RS-232/422/485 ports (COM1) 3x 3-wire RS-232 ports (COM2/3/4) or 1x RS-422/485 port (COM2)
Driftstemperatur	:	With 35W CPU -25°C to 60°C; With 65W CPU (installation of the optional fan kit is recommended) -10°C to 60°C) -25°C to 60°C
Chok/Vibration	:	Vibration MIL-STD-810H, Method 514.8, Category 4 Shock MIL-STD-810H, Method 516.8, Procedure I
Ethernet	:	2x 2.5GBASE-T Ethernet ports by Intel® I226-IT GbE controllers
Grafik	:	Integrated Intel® UHD Graphics 770 (32EU) / 730 (24EU)
Lyd	:	1x 3.5 mm jack for mic-in and speaker-out
Montering	:	Wall-mount (optional) or DIN-rail mount (optional)
Mål og vægt	:	2.5Kg



SPECIFICATIONS

RAM	:	Up to 32GB non-ECC DDR4 3200 SDRAM (one SODIMM slot)
EMC	:	CE/FCC Class A, according to EN 55032 & EN 55035
Dimensioner	:	212mm (W) x 165 mm (D) x 80 mm (H)

